

02-25-02

In the United States Patent and Trademark Office

	Mailed 200 Z Peb 21
Box Patent Application Commissioner for Patents Washington, District of Columbia 20231	
Sir:	
Please file the following enclosed patent application papers:	
Applicant #1, Name: Jon Geist	
Applicant #2, Name:	
Applicant #2, Name:	ing of CMOS integrated circuits
🔀 Specification, Claims, and Abstract: Nr. of Sheets30	_
Declaration: Date Signed: Z002 Feb 21	
Drawing(s): Nr. of Sheets Enc.: Formal: Informal: _	3
Small Entity Declaration of Inventor(s)	Non-Inventor / Assignee / Licensee
 Assignment enclosed with cover sheet and recordal fee; please re 	
Payment by check credit card (form PTO-2038 attached	
\$ 370.00 for filing fee (not more than thr	
additional if Assignment is enc	
L.1 \$ additional if Assignment is end	losed for recordal.
\square Information Disclosure Statement, Form PTO-1449, and listed re	ferences.
☐ Disclosure Document Program reference letter.	
☐ Pursuant to 35 U.S.C. §119(e)(i), applicant(s) claim priority of P filed	rovisional Patent Application Ser. Nr,
🗹 Return Receipt Postcard Addressed to Applicant #1.	
Request Under MPEP § 707.07(j): The undersigned, a prospatentable subject matter disclosed in this application, but feels Examiner draft one or more allowable claims for applicant.	
□ Request for Non-Publication: The undersigned requests that USC 122(6)(1). The undersigned certifies that the invention disc application filed in another country or under a multilateral internmenths after filing. The undersigned understands that if this apprinternational agreement, the PTO must be notified of such filing.	losed in this application has not and will not be the subject of an ational agreement that requires publication of applications 18 lication is filed in a foreign country or under such a multilateral
Very respectfully, Applicant #1 Signature 4410 Winding Oak Drive Address (Send Correspondence Here)	•
Applicant #1 Signature 94410 Winding Oak Drive	Applicant #2 Signature
Address (Send Correspondence Here) Olney MD 20832	Address
,	
Express Mail Label # EF 287668198 US	; ; Date of Deposit 200 Z Feb Z1

In the United States Patent and Trademark Office

Mailed 200 2 Feb 21

Box Patent Application Commissioner for Patents Washington, District of Columbia 20231

Fee Transmittal

First-Name	ed ApplicantTon Geist	
Title of Inv	ention: " I'm proved method for TMAH etching of CMOS in	tegrated circuits
Title of Invention: " Im proved method for TMAH etching of CMOS integra Total Payment Enclosed (From Calculation Below): \$ 370.00		Money Order
		attach Form PTO-2038)
Sir:		
Enclosed i	s the following small entity filing fee for the above patent application:	
Fee Code	Fee Description	Fee (\$)
214	Provisional Pat. Appn. Filing Fee	
201	Basic Utility Appn. Filing Fee	370,00
206	Basic Design Appn. Filing Fee	
	Subtotal (1)	370.00
203	Total Claims: $13 - 20 = -7$; X O (fee for each claim over 20)	=
202	Tot. Indep. Claims $2 - 3 = -/$; X 6 (fee for each indep. claim over	er 3) =
	Subtotal (2)	0,00
Total Payment Enclosed [Sum of Subtotals (1) and (2)]		370.00
Very resp	pottully "	
VOI 9 103PI	In Gent	
	of First-Named Applicant	
Jon	Gels'T	
Address	Winding Oak Drive	
010	ney MD 20832	